

RX Family

JPEG Encoder Module

Firmware Integration Technology

Introduction

This material explains usage of JPEG Encoder (JPEGE).

JPEG Encoder is only for encoding, and there are the following two libraries.

JPEG Encode Library: DCT, Quantization and Huffman encoding.

JPEG File Compress Library: Compress JPEG data using JPEG Encode Library.

Normally, the API for the JPEG File Compress Library is used to compress bitmap images into the JPEG image format. But since the source code for the JPEG File Compress Library is provided, users can also change the specifications to match the particular needs of their applications.

Target Device

RX Family

APPLICATION NOTE



Contents

1.	Structure of product	3
2.	Specification of library	4
2.1	Structure of software stack	4
2.2	Specification of JPEG File Compress Library	4
2.3	Development environment	5
2.4	for", "while" and "do while" statements	6
2.5	Specification of API	7
2.6	6 ROM size / RAM size / Stack size	8
2.7	Version information	10
2	2.7.1 RX600 (little endian)	10
2	2.7.2 RX600 (big endian)	10
2	2.7.3 RX200 (little endian)	11
2	2.7.4 RX200 (big endian)	11
3.	Usage of Libraries	12
3.1	Usage of JPEG File Compress library	12
3.2	Usage of JPEG Encode Library	12
4.	Adding Library to Your Project	13
4.1	Adding Library to CS+ Project	13
4.2	2 Adding Library to e ² studio Project	13
5.	Notes	14
6.	Software Update Information	15



1. Structure of product

Package name : JPEG Encoder for the RX Family V.1.03 Release 00

Table 1.1 Product Files of JPEG Encoder

File/Directory name		description	
JPE	EGE FIT Module (r_jpege_rx_v.1.03.zip)		
JPEGE config (r_config)			
	r_jpege_rx_config.h	JPEGE Config file (default setting)	
J	PEGE FIT Module body (r_jpege_rx)		
	JPEGE document (doc)		
	Japanese (ja)		
	r20an0263jj0103_rx_jpege.pdf	Introduction Guide	
	r20uw0122jj0100_jpege.pdf	User's Manual	
	English (en)		
	r20an0263ej0103_rx_jpege.pdf	Introduction Guide (this document)	
	r20uw0122ej0100_jpege.pdf	User's Manual	
	JPEGE Library (lib)		
	jpege_rx600_little.lib		
	jpege_rx600_big.lib		
	jpege_rx200_little.lib	JPEG Encode Library and header file	
	jpege_rx200_big.lib		
	r_jpeg.h		
	compress_jpege_rx600_little.lib		
	compress_jpege_rx600_big.lib		
	compress_jpege_rx200_little.lib	JPEG File Compress Library and header file	
	compress_jpege_rx200_big.lib		
	r_compress_jpege.h		
	r_stdint.h	Data type header file	
	r_mw_version.h	Version data header file	
	JPEG File Compress Library make environment (make_lib)		
	make_lib.zip	JPEG File Compress Library make environment (includes source code)	
	readme(readme.txt)	Readme	



2. Specification of library

2.1 Structure of software stack

This figure explains structure of software stack of JPEG Encoder.



Figure 2.1 Structure of Software Stack

2.2 Specification of JPEG File Compress Library

Specification of this JPEG File Compress Library is below.

Table 2.1 specification of JPEG Compress Library

Items		Specifications	
Output	Support format	JFIF	
JPEG File	Elements of color	3 colors (YCbCr)	
	Ratio of sample	4:2:2 (2x1,1x1,1x1) or 4:2:0 (2x2,1x1,1x1)	
	Image quality	A value in the range 1 to 128 may be specified.	
	Restart marker	Either none or an arbitrary interval may be set.	
	Comment	none	
	Exif	No support	
	Progressive	No support	
	Thumbnail	No support	
	Output units	Output buffers with an arbitrary size may be provided and the data can be stored to various media in units of that size.	
Input	Image format	RGB565 (16bit color), RGB888 (24bit color), YCbCr 4:2:2	
Image data	Input units	Data is read as single unit. (Reading divided into smaller units is not possible.)	

The source code of JPEG File Compress Library is attached so that a user can change specification.



2.3 Development environment

JPEG Encoder can run with this development environment below.

```
[IDE]
```

CS+ V8.13.00

e²studio 2025-01

[C compiler]

C/C++ Compiler Package for RX Family V.1.02 Release 01 or later

Library file is built with default compile option.

```
    compile option (RX600 little endian)
    -cpu=rx600 -output=obj="$(CONFIGDIR)\$(FILELEAF).obj" -nologo
    compile option (RX600 big endian)
    Adding "-endian=big" to default option.
```



2.4 for", "while" and "do while" statements

In this module, "for", "while" and "do while" statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with "WAIT_LOOP" as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with "WAIT_LOOP".

```
The following shows example of description.
```

```
while statement example :
/* WAIT LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}
for statement example :
/* Initialize reference counters to 0. */
/* WAIT LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)</pre>
{
    g_protect_counters[i] = 0;
}
do while statement example :
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */
```



2.5 Specification of API

Specification of JPEG Compress Library APIs are below.

Table 2.2 API (JPEG File Compress Library)

function name	outline
R_compress_jpeg	compress bitmap images into JPEG files

Note: Refer to the JPEG Encoder User's Manual to know details.

Specification of JPEG Encode Library APIs are below.

Table 2.3 API (JPEG Encode Library)

function name	outline
R_jpeg_add_quant_table	Registers Quantization table
R_jpeg_DCT	Executes DCT and quantization
R_jpeg_encode_one_block	Executes Huffman encoding
R_jpeg_writeDRI	Writes DRI
R_jpeg_writeRST	Writes RSTm
R_jpeg_writeEOI	Writes EOI
R_jpeg_flush_bits	Forcibly writes Huffman encoded data

Note: Refer to the JPEG Encoder User's Manual to know details.



2.6 ROM size / RAM size / Stack size

JPEG Encoder requires ROM/RAM/Stack size as below.

kind	section name	Attribute, Alignment	size [byte]	
			RX600, RX200	RX600, RX200
			little endian	big endian
ROM	P_jpeg_cmp_F (*)	code	3005	2990
	P_jpeg_cmp_S	code	2980	2980
	C_jpeg_cmp_F (*)	data, align=4	16	16
	C_jpeg_cmp_F_2 (*)	data, align=2	256	256
	C_jpeg_cmp_S	data, align=4	388	388
Total	-	-	6645	6630
RAM	B_jpeg_cmp_F (*)	data, align=4	1164	1164
	B_jpeg_cmp_F_2 (*)	data, align=2	128	128
	B_jpeg_cmp_F_1 (*)	data, align=1	384	384
Total	-	-	1676	1676

Note: (*): Recommends arranging to a high speed memory.

Table 2.5 ROM/RAM size (JPEG Encode Library)

Kind	section name	Attribute, Alignment	size [byte]	
			RX600, RX200	RX600, RX200
			little endlan	big endlan
ROM	P_jpeg_enc_F (*)	code	1050	1050
	P_jpeg_enc_F_8 (*)	code, align=8	644	644
	P_jpeg_enc_S	code	203	204
	C_jpeg_enc_F (*)	data, align=4	2536	2536
	C_jpeg_enc_F_1 (*)	data, align=1	64	64
	C_jpeg_enc_S	data, align=4	828	828
Total	-	-	5325	5326
RAM	-	-	0	0
Total	-	-	0	0

Note: (*): Recommends arranging to a high speed memory.



Table 2.6 Stack size (JPEG File Compress Library)

API function name	stack size [byte]		
	RX600, RX200 RX600, RX200		
	little endian	big endian	
R_compress_jpeg	296	296	

Table 2.7 Stack size (JPEG Encode Library)

API function name	stack size [byte]		
	RX600, RX200	RX600, RX200	
	little endian	big endian	
R_jpeg_add_quant_table	36	36	
R_jpeg_DCT	4	4	
R_jpeg_encode_one_block	60	60	
R_jpeg_writeDRI	12	12	
R_jpeg_writeRST	36	36	
R_jpeg_writeEOI	8	8	
R_jpeg_flush_bits	24	24	



2.7 Version information

Version information is stored in this library. Version information can be accessed if the header of this library is included. The data stored in this library is as follows.

2.7.1 RX600 (little endian)

JPEG File Compress Library (compress_jpege_rx600_little.lib)

```
#include "r_compress_jpegd.h"
```

```
Version infomation of a Library
R_compress_jpege_version.library[] =
"JPEG File Compress Library version 1.00 for the RX600 LITTLE endian.(Sep 12 2013, 11:40:46)"
```

Version infomation of a compiler R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx600_little.lib)

#include "r_jpeg.h"

```
Version infomation of a Library
R_jpege_version.library[] =
"JPEG Encode Library version 1.01 for the RX600 LITTLE endian.(Feb 18 2016, 21:07:57)"
```

Version infomation of a compiler

```
R_jpegd_version.complier = 0x01020100
```

2.7.2 RX600 (big endian)

JPEG File Compress Library (compress_jpege_rx600_big.lib)

```
#include "r_compress_jpege.h"
```

Version infomation of a Library R_compress_jpege_version.library[] = "JPEG File Compress Library version 1.00 for the RX600 BIG endian.(Sep 12 2013, 11:40:42)"

Version infomation of a compiler R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx600_big.lib)

```
#include "r_jpeg.h"
```

```
Version infomation of a Library
R_jpege_version.library[] =
"JPEG Encode Library version 1.01 for the RX600 BIG endian.(Feb 18 2016, 21:08:09)"
```

Version infomation of a compiler

 $R_jpegd_version.complier = 0x01020100$



2.7.3 RX200 (little endian)

JPEG File Compress Library (compress_jpege_rx200_little.lib)

#include "r_compress_jpege.h"

```
Version infomation of a Library
```

```
R_compress_jpege_version.library[] =
"JPEG File Compress Library version 1.00 for the RX200 LITTLE endian.(Sep 12 2013, 11:40:37)"
```

```
Version infomation of a compiler
```

R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx200_little.lib)

#include "r_jpeg.h"

```
Version infomation of a Library
R_jpege_version.library[] =
"JPEG Encode Library version 1.01 for the RX200 LITTLE endian.(Feb 18 2016, 21:08:15)"
```

Version infomation of a compiler R_jpegd_version.complier = 0x01020100

2.7.4 RX200 (big endian)

JPEG File Compress Library (compress_jpege_rx200_big.lib)

```
#include "r_compress_jpege.h"
```

```
Version infomation of a Library
R_compress_jpege_version.library[] =
"JPEG File Compress Library version 1.00 for the RX200 BIG endian.(Sep 12 2013, 11:40:33)"
```

Version infomation of a compiler R_expand_jpegd_version.complier = 0x01020100

JPEG Encode Library (jpege_rx200_big.lib)

#include "r_jpeg.h"

```
Version infomation of a Library
R_jpege_version.library[] =
"JPEG Encode Library version 1.01 for the RX200 BIG endian.(Feb 18 2016, 21:08:22)"
```

Version infomation of a compiler R_jpegd_version.complier = 0x01020100



3. Usage of Libraries

3.1 Usage of JPEG File Compress library

Please link the library file to user application.

RX600 little endian:	jpege_rx600_little.lib, compress_jpege_rx600_little.lib
RX600 big endian:	jpege_rx600_big.lib, compress_jpege_rx600_big.lib
RX200 little endian:	jpege_rx200_little.lib, compress_jpege_rx200_little.lib
RX200 big endian:	jpege_rx200_big.lib, compress_jpege_rx200_big.lib

Please include the header files with library.

#include "r compress jpege.h"

3.2 Usage of JPEG Encode Library

Please link the library file to user application.

RX600 little endian:	jpege_rx600_little.lib
RX600 big endian:	jpege_rx600_big.lib
RX200 little endian:	jpege_rx200_little.lib
RX200 big endian:	jpege_rx200_big.lib

Please include the header files with library.

#include "r_jpeg.h"



4. Adding Library to Your Project

The lib folder has all Libraries for RX Family. Add the required library for your project.

4.1 Adding Library to CS+ Project

Please refer to the Adding Firmware Integration Technology Modules to Projects.

• Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)

Adding Library

- (1) Adding FIT modules to projects.
- (2) Open: Project Tree >> File >> [FIT Module name] >> lib.
- (3) All Libraries will be linked for building. Please remove the Libraries excluding your needing libraries. Right click on the removed library file name, select "Remove from Project".

4.2 Adding Library to e² studio Project

Please refer to the Adding Firmware Integration Technology Modules to Projects.

• Adding Firmware Integration Technology Modules to Projects (R01AN1723)

Adding Library

- (1) Adding FIT modules to projects.
- (2) Right click on the project name in the Project Explorer, then choose "Properties" from the pop-up menu.
- (3) The "Properties" dialog is shown. The right side of this dialog changes as you select categories on the left. Select the following in order:

"C/C++ Build" >> "Settings" >> "Linker" >> "Input"

Click the "Add..." button.

(4) Adding library.



5. Notes

- This library uses DSP instructions. Please push/pop accumulator register (ACC) in user interrupts function using accumulator, because DSP instructions uses accumulator (RX600).
- This library can be used with Microcontroller Options fint_register=0 (Fast interrupt vectorregister [None]). The default for this option is fint_register=0.
- This library is using Application Notes "Color Space Conversion Using the DSP Instructions" [R01AN0225EJ0100]. Refer to it to know details.



Package version	Date	Description
V.1.00 Release 00	Mar 17, 2015	First release
V.1.01 Release 00	Apr 01, 2016	Updated version number with the xml file revision.
V.1.02 Release 00	Nov 15, 2024	Added support for adding WAIT_LOOP comments.
V.1.03 Release 00	Mar 20, 2025	Changed the disclaimer in program sources

6. Software Update Information



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Revision History

		Description	
Rev.	Date	Page	Summary
1.00	Mar.17.15	—	First edition issued
1.01	Apr.01.16	—	Update the xml file for FIT
1.02	Nov.15.24	6	Added 2.4" for", "while" and "do while" statements
1.03	Mar.20.25	3	Update 1. Structure of product.
		15	Update 6. Software Update Information

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

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The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

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5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

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